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- **Qualified for Automotive Applications**
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 150 V (TLC2252/52A) and 100 V (TLC2254/54A) Using Machine Model (C = 200 pF, R = 0)
- **Output Swing Includes Both Supply Rails**
- Low Noise . . . 19 nV/ $\sqrt{\text{Hz}}$  Typ at f = 1 kHz
- Low Input Bias Current . . . 1 pA Typ
- Fully Specified for Both Single-Supply and **Split-Supply Operation**

- Very Low Power . . . 35 μA Per Channel Typ
- Common-Mode Input Voltage Range **Includes Negative Rail**
- **Low Input Offset Voltage** 850  $\mu$ V Max at T<sub>A</sub> = 25°C (TLC225xA)
- Macromodel Included
- Performance Upgrades for the TS27L2/L4 and TLC27L2/L4

#### description

The TLC2252 and TLC2254 are dual and quadruple operational amplifiers from Texas Instruments. Both devices exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. The TLC225x family consumes only 35 µA of supply current per channel. This micropower operation makes them good choices for battery-powered applications. The noise performance has been dramatically improved over previous generations of CMOS amplifiers. Looking at Figure 1, the TLC225x has a noise level of 19 nV/ $\sqrt{\text{Hz}}$  at 1kHz; four times lower than competitive micropower solutions.

The TLC225x amplifiers, exhibiting high input impedance and low noise, are excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels. these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single or split



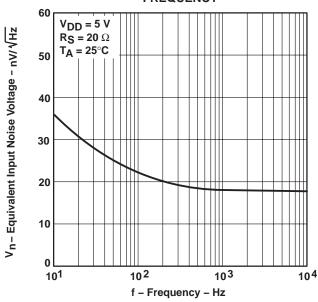


Figure 1

supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLC225xA family is available and has a maximum input offset voltage of 850 μV. This family is fully characterized at 5 V and  $\pm 5$  V.

The TLC2252/4 also makes great upgrades to the TLC27L2/L4 or TS27L2/L4 in standard designs. They offer increased output dynamic range, lower noise voltage, and lower input offset voltage. This enhanced feature set allows them to be used in a wider range of applications. For applications that require higher output drive and wider input voltage ranges, see the TLV2432 and TLV2442 devices. If the design requires single amplifiers, please see the TLV2211/21/31 family. These devices are single rail-to-rail operational amplifiers in the SOT-23 package. Their small size and low power consumption, make them ideal for high density, battery-powered equipment.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Advanced LinCMOS is a trademark of Texas Instruments



#### TLC225x-Q1, TLC225xA-Q1 Advanced LinCMOS™ RAIL-TO-RAIL VERY LOW-POWER OPERATIONAL AMPLIFIERS

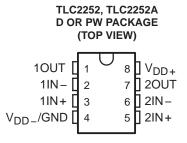
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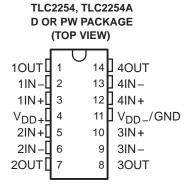
#### ORDERING INFORMATION†

TA	V <sub>IO</sub> max AT 25°C	PACK	AGE <sup>‡</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING			
	050 1/	SOIC (D)	Tape and reel	TLC2252AQDRQ1	2252AQ			
	850 μV	TSSOP (PW)	Tape and reel	TLC2252AQPWRQ1	2252AQ			
	4550 1/	SOIC (D)	Tape and reel	TLC2252QDRQ1	2252Q1			
4000 to 40500	1550 μV	TSSOP (PW)	Tape and reel					
-40°C to 125°C	050\/	SOIC (D)	Tape and reel	TLC2254AQDRQ1	TLC2254AQ1			
	850 μV	TSSOP (PW)	Tape and reel	TLC2254AQPWRQ1	2254AQ			
	4550 \/	SOIC (D)	Tape and reel	TLC2254QDRQ1	TLC2254Q1			
	1550 μV	TSSOP (PW)	Tape and reel	TLC2254QPWRQ1	2254Q1			

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

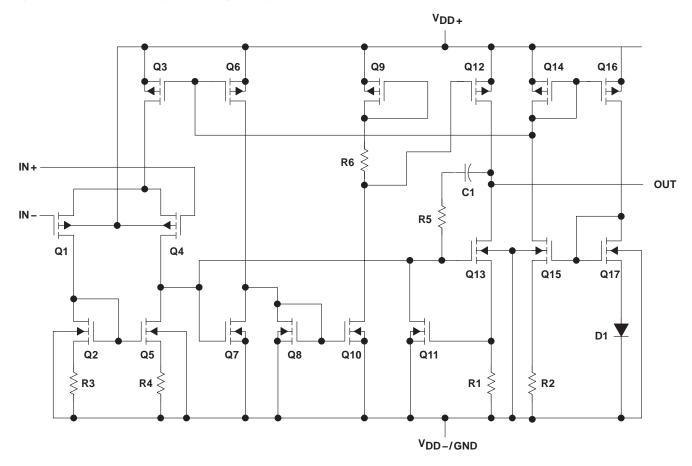
<sup>‡</sup> Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.





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#### equivalent schematic (each amplifier)



ACTUAL DE	VICE COMPONENT	COUNT
COMPONENT	TLC2252	TLC2254
Transistors	38	76
Resistors	30	56
Diodes	9	18
Capacitors	3	6

<sup>†</sup> Includes both amplifiers and all ESD, bias, and trim circuitry

#### TLC225x-Q1, TLC225xA-Q1 Advanced LinCMOS™ RAIL-TO-RAIL VERY LOW-POWER OPERATIONAL AMPLIFIERS

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>DD+</sub> (see Note 1)	8 V
Supply voltage, V <sub>DD</sub> (see Note 1)	8 V
Differential input voltage, V <sub>ID</sub> (see Note 2)	±16 V
Input voltage, V <sub>I</sub> (any input, see Note 1)	±8 V
Input current, I <sub>I</sub> (each input)	±5 mA
Output current, I <sub>O</sub>	±50 mA
Total current into V <sub>DD+</sub>	±50 mA
Total current out of V <sub>DD</sub>	±50 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total dissipation	
Operating free-air temperature range, T <sub>A</sub> : Q suffix	–40°C to 125°C
Storage temperature range, T <sub>stq</sub>	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between VDD+ and VDD -.

- Differential voltages are at IN+ with respect to IN−. Excessive current flows when input is brought below V<sub>DD</sub> − 0.3 V.
- 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
D-8	724 mW	5.8 mW/°C	464 mW	377 mW	144 mW
D-14	950 mW	7.6 mW/°C	608 mW	450 mW	190 mW
PW-8	525 mW	4.2 mW/°C	336 mW	273 mW	105 mW
PW-14	700 mW	5.6 mW/°C	448 mW	364 mW	140 mW

#### recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, $V_{DD\pm}$	±2.2	±8	V
Input voltage range, V <sub>I</sub>	$V_{DD-}$	V <sub>DD+</sub> -1.5	V
Common-mode input voltage, V <sub>IC</sub>	$V_{DD-}$	V <sub>DD+</sub> -1.5	V
Operating free-air temperature, T <sub>A</sub>	-40	125	°C

<sup>‡</sup>Referenced to 2.5 V



#### electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$ (unless otherwise noted)

	DADAMETED	TEGT 001	DITIONS		TL	C2252-0	Q1	TLC2252A-           MIN         TYP           200           0.5           0.003           0.5           1           0         -0.3           to         to           4         4.2           0         to           4.98         4.9           4.9         4.94           4.8         4.88           0.01         0.09           0.7         100           10         1700           1012         8           200         70           80         95           80         95	Q1		
	PARAMETER	TEST CON	DITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
.,	lanut effect veltage			25°C		200	1500		200	850	/
VIO	Input offset voltage			Full range			1750			1000	μV
αΛΙΟ	Temperature coefficient of input offset voltage			25°C to 125°C		0.5			0.5		μV/°C
	Input offset voltage long-term drift (see Note 4)	$V_{DD\pm} = \pm 2.5 \text{ V},$ $V_{O} = 0,$	$V_{IC} = 0,$ R <sub>S</sub> = 50 $\Omega$	25°C		0.003			0.003		μV/mo
IIO	Input offset current			25°C		0.5	60		0.5	60	pА
10	input onset current	]		Full range			1000			1000	P/ t
I <sub>IB</sub>	Input bias current			25°C		1	60		1	60	pА
'ID	input blub current			Full range			1000			1000	P/\
	Common-mode input			25°C	0 to 4	-0.3 to 4.2		to	to		
VICR	voltage range	$R_S = 50 \Omega$ ,	$ V_{IO}  \le 5 \text{ mV}$	Full range	0 to 3.5			to			V
		$I_{OH} = -20  \mu A$		25°C		4.98			4.98		
V	High-level output	Ja 75 A		25°C	4.9	4.94		4.9	4.94		V
VOH	voltage	I <sub>OH</sub> = -75 μA		Full range	4.8			4.8			V
		ΙΟΗ = –150 μΑ		25°C	4.8	4.88		4.8	4.88		
		$V_{IC} = 2.5 V$ ,	$I_{OL} = 50 \mu A$	25°C		0.01			0.01		
	Low lovel output	thut 1/10 = 2.5 \/ 101 = 500 114	0.15	_							
VOL	Low-level output voltage	VIC = 2.5 V,	10L = 300 μΑ	Full range			0.15			0.15	V
	3.00	V <sub>IC</sub> = 2.5 V,	I <sub>OL</sub> = 4 mA	25°C		0.8	1		0.7	1	
		VIC - 2.0 V,	10L = +110X	Full range			1.2			1.2	
	Large-signal differential	V 2 F V	R <sub>L</sub> = 100 kه	25°C	100	350		100	350		
AVD	voltage amplification	$V_{IC} = 2.5 \text{ V},$ $V_{O} = 1 \text{ V to 4 V}$		Full range	10			10			V/mV
		0 1	$R_L = 1 M\Omega^{\ddagger}$	25°C		1700			1700		
rid	Differential input resistance			25°C		1012			1012		Ω
r <sub>ic</sub>	Common-mode input resistance			25°C		10 <sup>12</sup>			10 <sup>12</sup>		Ω
c <sub>ic</sub>	Common-mode input capacitance	f = 10 kHz,	f = 10 kHz,	25°C		8			8		pF
z <sub>O</sub>	Closed-loop output impedance	f = 25 kHz,	A <sub>V</sub> = 10	25°C		200			200		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = 0 \text{ to } 2.7 \text{ V},$ Rs = 50 \Omega	V <sub>O</sub> = 2.5 V,	25°C Full range	70 70	83			83		dB
ksvR	Supply-voltage rejection ratio (ΔVDD/ΔVIO)	$V_{DD} = 4.4 \text{ V to 1}$ $V_{IC} = V_{DD}/2$ ,	6 V, No load	25°C Full range	80	95		80	95		dB
				25°C		70	125		70	125	
$I_{DD}$	Supply current	$V_O = 2.5 V$ ,	No load	Full range			150			150	μΑ
		<u> </u>		. an range			.00			.00	

<sup>†</sup> Full range is -40°C to 125°C for Q suffix.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^{\circ}C$  extrapolated to  $T_A = 25$ °C using the Arrhenius equation and assuming an activation energy of 0.96 eV.



<sup>‡</sup>Referenced to 2.5 V

# TLC225x-Q1, TLC225xA-Q1 Advanced LinCMOS™ RAIL-TO-RAIL VERY LOW-POWER OPERATIONAL AMPLIFIERS SGLS188B - OCTOBER 2003 - REVISED APRIL 2008

## operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

	ADAMETED	TEST SOUD	ITIONIO	- +	TLO	C2252-C	21	TLC	2252A-	Q1	LINUT
	ARAMETER	TEST COND	IIIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	Class nata at south	V- 05V4025V		25°C	0.07	0.12		0.07	0.12		
SR	Slew rate at unity gain	$V_O = 0.5 \text{ V to } 3.5 \text{ V},$ $R_L = 100 \text{ k}\Omega^{\ddagger},$	$C_L = 100 \text{ pF}^{\ddagger}$	Full range	0.05			0.05			V/µs
.,	Equivalent input	f = 10 Hz		25°C		36			36		nV/√ <del>Hz</del>
V <sub>n</sub>	noise voltage	f = 1 kHz		25°C		19			19		110/1012
.,	Peak-to-peak	f = 0.1 Hz to 1 Hz		25°C		0.7			0.7		.,
V <sub>N(PP)</sub>	equivalent input noise voltage	f = 0.1 Hz to 10 Hz		25°C		1.1			1.1		μV
In	Equivalent input noise current			25°C		0.6			0.6		fA√Hz
THD + N	Total harmonic	$V_O = 0.5 \text{ V to } 2.5 \text{ V},$ f = 10 kHz,	A <sub>V</sub> = 1	25°C		0.2%			0.2%		
THD + N	distortion plus noise	$R_L = 50 \text{ k}\Omega^{\ddagger}$	A <sub>V</sub> = 10	25°C		1%			1%		
	Gain-bandwidth product	f = 50 kHz, C <sub>L</sub> = 100 pF <sup>‡</sup>	$R_L = 50 \text{ k}\Omega^{\ddagger}$ ,	25°C		0.2			0.2		MHz
ВОМ	Maximum output- swing bandwidth	$V_{O(PP)} = 2 \text{ V},$ $R_L = 50 \text{ k}\Omega^{\ddagger},$	$A_V = 1,$ $C_L = 100 \text{ pF}^{\ddagger}$	25°C		30			30		kHz
φm	Phase margin at unity gain	$R_L = 50 \text{ k}\Omega^{\ddagger}$ ,	C <sub>L</sub> = 100 pF‡	25°C		63°			63°		
	Gain margin			25°C		15			15		dB

<sup>†</sup> Full range is -40°C to 125°C for Q suffix. ‡ Referenced to 2.5 V



# electrical characteristics at specified free-air temperature, $V_{DD\pm} = \pm 5 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS	<b>+.</b> +	TL	C2252-0	21	TLO	C2252A-	Q1	
	PARAMETER	1231 00	DNDITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
V	Input offset voltage			25°C		200	1500		200	850	\
VIO	Input offset voltage			Full range			1750			1000	μV
αΛΙΟ	Temperature coefficient of input offset voltage			25°C to 125°C		0.5			0.5		μV/°C
	Input offset voltage long- term drift (see Note 4)	$V_{IC} = 0,$ $R_S = 50 \Omega$	$V_O = 0$ ,	25°C		0.003			0.003		μV/mo
lio	Input offset current			25°C		0.5	60		0.5	60	рA
lio	input onset current			Full range			1000			1000	PΛ
lın	Input bias current			25°C		1	60		1	60	рА
ΙΒ	input bias current			Full range			1000			1000	PΛ
Vion	Common-mode input	Po = 50 O	V <sub>IO</sub>   ≤5 mV	25°C	–5 to 4	-5.3 to 4.2		–5 to 4	-5.3 to 4.2		V
VICR	voltage range	115 - 30 22,	V   23    V	Full range	-5 to 3.5			-5 to 3.5		60 1000 60 1000 3	V
		$I_O = -20 \mu A$		25°C		4.98			4.98		
\/a	Maximum positive peak	100	^	25°C	4.9	4.93		4.9	4.93		V
VOM+	output voltage	$I_{O} = -100 \mu$	4	Full range	4.7			4.7			V
		$I_0 = -200 \mu$	4	25°C	4.8	4.86		4.8	4.86	MAX 850 1000 60 1000 60	
		$V_{IC} = 0$ ,	$I_O = 50 \mu\text{A}$	25°C		-4.99			-4.99		
	Markeyer	V: 0	I <sub>O</sub> = 500 μA	25°C	-4.85	-4.91		-4.85	-4.91		
VOM−	Maximum negative peak output voltage	$V_{IC} = 0,$	10 = 300 μΑ	Full range	-4.85			-4.85			V
	1 1 0	V <sub>IC</sub> = 0,	$I_O = 4 \text{ mA}$	25°C	-4	-4.3		-4	-4.3		
		VIC = 0,	10 = 4 IIIA	Full range	-3.8			-3.8			
	Lorge signal differential		R <sub>L</sub> = 100 kΩ	25°C	40	150		40	150		
AVD	Large-signal differential voltage amplification	$V_O = \pm 4 V$		Full range	10			10			V/mV
			$R_L = 1 M\Omega$	25°C		3000			3000		
<sup>r</sup> id	Differential input resistance			25°C		10 <sup>12</sup>			10 <sup>12</sup>		Ω
r <sub>ic</sub>	Common-mode input resistance			25°C		10 <sup>12</sup>			1012		Ω
c <sub>ic</sub>	Common-mode input capacitance	f = 10 kHz,	P package	25°C		8			8		pF
z <sub>o</sub>	Closed-loop output impedance	f = 25 kHz,	A <sub>V</sub> = 10	25°C		190			190		Ω
01100	Common-mode	$V_{IC} = -5 \text{ V to}$	o 2.7 V,	25°C	75	88		75	88		
CMRR	rejection ratio	$V_O = 0$ ,	$R_S = 50 \Omega$	Full range	75			75			dB
	Supply-voltage rejection	$V_{DD} = \pm 2.2$	V to ±8 V,	25°C	80	95		80	95		-10
ksvr	ratio (ΔV <sub>DD±</sub> /ΔV <sub>IO</sub> )	$V_{IC} = 0$ ,	No load	Full range	80			80			dB
	Complete sources !	V- 0511	2	25°C		80	125		80	125	_
IDD	Supply current	$V_0 = 2.5 V$ ,	No load	Full range			150			150	μΑ

<sup>†</sup> Full range is –40°C to 125°C for Q suffix.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^{\circ}C$  extrapolated to T<sub>A</sub> = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.



# TLC225x-Q1, TLC225xA-Q1 Advanced LinCMOS™ RAIL-TO-RAIL VERY LOW-POWER OPERATIONAL AMPLIFIERS SGLS188B - OCTOBER 2003 - REVISED APRIL 2008

# operating characteristics at specified free-air temperature, $V_{DD\pm}$ = $\pm 5~\text{V}$

	DADAMETED	TEST SON	DITIONS	- +	TLO	C2252-G	21	TLC	2252A-	Q1	LINUT
	PARAMETER	TEST CON	DITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
		V- +0.V	D: 400 l-O	25°C	0.07	0.12		0.07	0.12		
SR	Slew rate at unity gain	$V_O = \pm 2 \text{ V},$ $C_L = 100 \text{ pF}$	$R_L = 100 \text{ k}\Omega$ ,	Full range	0.05			0.05			V/μs
,,	Equivalent input noise	f = 10 Hz		25°C		38			38		->//
Vn	voltage	f = 1 kHz		25°C		19			19		nV/√Hz
.,	Peak-to-peak equivalent	f = 0.1 Hz to 1 Hz	Z	25°C		0.8			0.8		.,
V <sub>N(PP)</sub>	input noise voltage	f = 0.1 Hz to 10 H	Нz	25°C		1.1			1.1		μV
In	Equivalent input noise current			25°C		0.6			0.6		fA√Hz
	Total harmonic distortion	$V_0 = \pm 2.3 \text{ V},$	A <sub>V</sub> = 1			0.2%			0.2%		
THD + N	plus noise	$R_L = 50 \text{ k}\Omega$ , f = 10  kHz	A <sub>V</sub> = 10	25°C		1%			1%		
	Gain-bandwidth product	f =10 kHz, C <sub>L</sub> = 100 pF	$R_L = 50 \text{ k}\Omega$ ,	25°C		0.21			0.21		MHz
Вом	Maximum output-swing bandwidth	$V_{O(PP)} = 4.6 \text{ V},$ $R_{L} = 50 \text{ k}\Omega,$	A <sub>V</sub> = 1, C <sub>L</sub> = 100 pF	25°C		14			14		kHz
φm	Phase margin at unity gain	R <sub>L</sub> = 50 kΩ,	C <sub>L</sub> = 100 pF	25°C		63°			63°		
	Gain margin			25°C		15			15		dB

<sup>†</sup> Full range is –40°C to 125°C for Q suffix.



#### electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$ (unless otherwise noted)

	DADAMETED	TEST CON	IDITIONS	<b></b> +	TL	C2254-0	ุว1	TLO	C2254A-	Q1	UNIT
	PARAMETER	TEST CON	IDITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNII
V	Input offset voltage			25°C		200	1500		200	850	\/
VIO	Input offset voltage			Full range			1750			1000	μV
αΝΙΟ	Temperature coefficient of input offset voltage			25°C to 125°C		0.5			0.5		μV/°C
	Input offset voltage long-term drift (see Note 4)	$V_{DD\pm} = \pm 2.5 \text{ V},$ $V_{O} = 0,$	$V_{IC} = 0,$ RS = 50 $\Omega$	25°C		0.003			0.003		μV/mo
lio	Input offset current			25°C		0.5	60		0.5	60	pА
10	input onset durient	]		125°C			1000			1000	P/\
I <sub>IB</sub>	Input bias current			25°C		1	60		1	60	рA
,ID	mpar blad darront			125°C			1000			1000	P/ (
Vion	Common-mode input	R <sub>S</sub> = 50 Ω,	V <sub>IO</sub>   ≤5 mV	25°C	0 to 4	-0.3 to 4.2		0 to 4	-0.3 to 4.2		V
VICR	voltage range	NS = 50 22,	v O    ≥2 111 v	Full range	0 to 3.5			0 to 3.5			V
		$I_{OH} = -20  \mu A$		25°C		4.98			4.98		
.,	High-level output			25°C	4.9	4.94		4.9	4.94		.,
VOH	voltage	I <sub>OH</sub> = -75 μA		Full range	4.8			4.8			V
		$I_{OH} = -150 \mu A$		25°C	4.8	4.88		4.8	4.88		
		$V_{IC} = 2.5 \text{ V},$	I <sub>OL</sub> = 50 μA	25°C		0.01			0.01		
	Lour lovel output	V <sub>IC</sub> = 2.5 V,	I <sub>OL</sub> = 500 μA	25°C		0.09	0.15		0.09	0.15	
VOL	Low-level output voltage	V  C = 2.5 V,	10L = 300 μΑ	Full range			0.15			0.15	V
	33	V <sub>IC</sub> = 2.5 V,	$I_{OL} = 4 \text{ mA}$	25°C		8.0	1		0.7	1	
		V <sub>1</sub> C = 2.0 v,		Full range			1.2			1.2	
	Large-signal	V <sub>IC</sub> = 2.5 V,	$R_L = 100 \text{ k}\Omega^{\ddagger}$	25°C	100	350		100	350		
AVD	differential	$V_0 = 1 \text{ V to 4 V}$		Full range	10			10			V/mV
	voltage amplification		$R_L = 1 M\Omega^{\ddagger}$	25°C		1700			1700		
r <sub>i(d)</sub>	Differential input resistance			25°C		10 <sup>12</sup>			10 <sup>12</sup>		Ω
r <sub>i(c)</sub>	Common-mode input resistance			25°C		1012			1012		Ω
c <sub>i(c)</sub>	Common-mode input capacitance	f = 10 kHz,	N package	25°C		8			8		pF
z <sub>O</sub>	Closed-loop output impedance	f = 25 kHz,	A <sub>V</sub> = 10	25°C		200			200		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = 0 \text{ to } 2.7 \text{ V},$ $R_S = 50 \Omega$	V <sub>O</sub> = 2.5 V,	25°C Full range	70 70	83		70 70	83		dB
	Supply-voltage	-		25°C	80	95		80	95		
ksvr	rejection ratio (ΔVDD/ΔVIO)	$V_{DD} = 4.4 \text{ V to 1}$ $V_{IC} = V_{DD}/2$ ,	6 V, No load	Full range	80	90		80	90		dB
	Supply current			25°C		140	250		140	250	_
IDD	(four amplifiers)	$V_0 = 2.5 V$ ,	No load	Full range			300			300	μΑ

<sup>†</sup> Full range is –40°C to 125°C for Q suffix.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^{\circ}C$  extrapolated to  $T_A = 25^{\circ}C$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.



<sup>‡</sup>Referenced to 2.5 V

# TLC225x-Q1, TLC225xA-Q1 Advanced LinCMOS™ RAIL-TO-RAIL VERY LOW-POWER OPERATIONAL AMPLIFIERS SGLS188B - OCTOBER 2003 - REVISED APRIL 2008

## operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

	ADAMETED	TEST SOUD	ITIONIO	- +	TLO	C2254-G	Q1	TLC	2254A-	Q1	
P.	ARAMETER	TEST COND	ITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	Clay rate at unity	$V_0 = 0.5 \text{ V to } 3.5 \text{ V},$		25°C	0.07	0.12		0.07	0.12		
SR	Slew rate at unity gain	$R_L = 100 \text{ k}\Omega^{\ddagger},$ $C_L = 100 \text{ pF}^{\ddagger}$		Full range	0.05			0.05			V/µs
.,	Equivalent input	f = 10 Hz		25°C		36			36		nV/√ <del>Hz</del>
Vn	noise voltage	f = 1 kHz		25°C		19			19		nv/√HZ
.,	Peak-to-peak	f = 0.1 Hz to 1 Hz		25°C		0.7			0.7		.,
V <sub>N(PP)</sub>	equivalent input noise voltage	f = 0.1 Hz to 10 Hz		25°C		1.1			1.1		μV
In	Equivalent input noise current			25°C		0.6			0.6		fA/√ <del>Hz</del>
TUD . N	Total harmonic	$V_0 = 0.5 \text{ V to } 2.5 \text{ V},$	A <sub>V</sub> = 1	0500		0.2%			0.2%		
THD + N	distortion plus noise	f = 20  kHz, $R_L = 50 \text{ k}\Omega^{\ddagger}$	A <sub>V</sub> = 10	25°C		1%			1%		
	Gain-bandwidth product	f = 50  kHz, $C_L = 100 \text{ pF}^{\ddagger}$	$R_L = 50 \text{ k}\Omega^{\ddagger}$ ,	25°C		0.2			0.2		MHz
ВОМ	Maximum output- swing bandwidth	$V_{O(PP)} = 2 V,$ $R_L = 50 \text{ k}\Omega^{\ddagger},$	$A_V = 1,$ $C_L = 100 \text{ pF}^{\ddagger}$	25°C		30			30		kHz
φm	Phase margin at unity gain	$R_L = 50 \text{ k}\Omega^{\ddagger}$ ,	C <sub>L</sub> = 100 pF‡	25°C		63°	·		63°		
	Gain margin			25°C		15			15		dB

<sup>†</sup> Full range is –40°C to 125°C for Q suffix. ‡ Referenced to 2.5 V



# electrical characteristics at specified free-air temperature, $V_{DD\pm}$ = $\pm 5$ V (unless otherwise noted)

	DADAMETED	TEST CO	NULTIONS	- +	TL	C2254-0	Q1	TLC	C2254A-	Q1	
	PARAMETER	1231 00	ONDITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
.,	least effect will as			25°C		200	1500		200	850	.,
V <sub>IO</sub>	Input offset voltage			Full range			1750			1000	μV
αΛΙΟ	Temperature coefficient of input offset voltage	]		25°C to 125°C		0.5			0.5		μV/°C
	Input offset voltage long-term drift (see Note 4)	$V_{IC} = 0,$ $R_S = 50 \Omega$	$V_{O} = 0,$	25°C		0.003			0.003		μV/mo
	level effect comment			25°C		0.5	60		0.5	60	A
lio	Input offset current			125°C			1000			1000	pA
	Level Plan server			25°C		1	60		1	60	A
lΒ	Input bias current			125°C			1000			1000	рA
Vion	Common-mode input	Po = 50 O	1\(\(\alpha\)   < 5 m\(\lambda\)	25°C	–5 to 4	-5.3 to 4.2		-5 to 4	-5.3 to 4.2		V
VICR	voltage range	KS = 50 12,	V <sub>IO</sub>   ≤5 mV	Full range	-5 to 3.5			-5 to 3.5		4.98 4.93	V
		$I_{O} = -20 \mu$	١	25°C		4.98			4.98		
.,	Maximum positive peak	1 400	^	25°C	4.9	4.93		4.9	4.93		.,
VOM+	output voltage	$I_{O} = -100 \mu$	А	Full range	4.7			4.7			V
		$I_{O} = -200 \mu$	A	25°C	4.8	4.86		4.8	4.86		
		V <sub>IC</sub> = 0,	I <sub>O</sub> = 50 μA	25°C		-4.99			-4.99		
				25°C	-4.85	-4.91		-4.85	-4.91		
VOM-	Maximum negative peak output voltage	$V_{IC} = 0$ ,	$I_{O} = 500  \mu A$	Full range	-4.85			-4.85			V
	output voitage			25°C	-4	-4.3		-4	-4.3		
		$V_{IC} = 0$ ,	$I_O = 4 \text{ mA}$	Full range	-3.8			-3.8			
				25°C	40	150		40	150		
AVD	Large-signal differential voltage amplification	V <sub>O</sub> = ±4 V	$R_L = 100 \text{ k}\Omega$	Full range	10			10			V/mV
	voltage amplification		$R_L = 1 M\Omega$	25°C		3000			3000		
r <sub>i(d)</sub>	Differential input resistance		•	25°C		1012			1012		Ω
r <sub>i(c)</sub>	Common-mode input resistance			25°C		1012			1012		Ω
<sup>C</sup> i(c)	Common-mode input capacitance	f = 10 kHz,	N package	25°C		8			8		pF
z <sub>o</sub>	Closed-loop output impedance	f = 25 kHz,	A <sub>V</sub> = 10	25°C		190			190		Ω
CMDD	Common-mode rejection	V <sub>IC</sub> = -5 V	to 2.7 V,	25°C	75	88		75	88		.10
CMRR	ratio	$V_{O} = 0,$	$R_S = 50 \Omega$	Full range	75			75			dB
L	Supply-voltage rejection	$V_{DD\pm} = \pm 2$	.2 V to ±8 V,	25°C	80	95		80	95		
ksvr	ratio (ΔV <sub>DD±</sub> /ΔV <sub>IO</sub> )	VIC = VDD/		Full range	80			80			dB
	Supply current	V- 0	Nolood	25°C		160	250		160	250	^
I <sub>DD</sub>	(four amplifiers)	$V_{O} = 0,$	No load	Full range			300			300	μΑ

<sup>†</sup> Full range is –40°C to 125°C for Q suffix.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^{\circ}C$  extrapolated to  $T_A = 25^{\circ}C$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.



# TLC225x-Q1, TLC225xA-Q1 Advanced LinCMOS™ RAIL-TO-RAIL VERY LOW-POWER OPERATIONAL AMPLIFIERS SGLS188B - OCTOBER 2003 - REVISED APRIL 2008

# operating characteristics at specified free-air temperature, $V_{DD\pm}$ = $\pm 5~\text{V}$

PARAMETER		TEST CONDITIONS		T <sub>A</sub> †	TLC2254-Q1			TLC2254A-Q1			LINUT	
					MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
	Slew rate at unity gain	V <sub>O</sub> = ±2 V, C <sub>L</sub> = 100 pF	$R_L = 100 \text{ k}\Omega$ ,	25°C	0.07	0.12		0.07	0.12			
SR				Full range	0.05			0.05			V/μs	
Vn	Equivalent input noise voltage	f = 10 Hz		25°C		38			38		nV/√ <del>Hz</del>	
		f = 1 kHz	25°C	19			19	IIV/VH2				
.,	Peak-to-peak	f = 0.1 Hz to 1 Hz		25°C		0.8			0.8			
V <sub>N(PP)</sub>	equivalent input noise voltage	f = 0.1 Hz to 10 H	25°C		1.1	1.1			μV			
In	Equivalent input noise current		25°C	0.6		0.6		fA/√ <del>Hz</del>				
THD + N	Total harmonic distortion plus noise	$V_0 = \pm 2.3 \text{ V},$	A <sub>V</sub> = 1	2500		0.2%			0.2%			
		$R_L = 50 \text{ k}\Omega$ , f = 20  kHz		25°C		1%			1%			
	Gain-bandwidth product	f =10 kHz, C <sub>L</sub> = 100 pF	$R_L = 50 \text{ k}\Omega$ ,	25°C		0.21			0.21		MHz	
ВОМ	Maximum output-swing bandwidth	$V_{O(PP)} = 4.6 \text{ V},$ $R_{L} = 50 \text{ k}\Omega,$	A <sub>V</sub> = 1, C <sub>L</sub> = 100 pF	25°C		14			14		kHz	
φm	Phase margin at unity gain	$R_L = 50 \text{ k}\Omega$ , $C_L = 100 \text{ p}$	C <sub>L</sub> = 100 pF	25°C		63°	·		63°			
	Gain margin			25°C		15			15		dB	

<sup>†</sup> Full range is –40°C to 125°C for Q suffix.



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V <sub>IO</sub>	Input offset voltage	Distribution vs Common-mode input voltage	2 – 5 6, 7
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αVIO			12
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VI	Input voltage range	vs Supply voltage vs Free-air temperature	13 14
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$V_{OL}$	Low-level output voltage	vs Low-level output current	16, 17
V <sub>OM+</sub>	Maximum positive peak output voltage	vs Output current	18
V <sub>OM</sub> -	Maximum negative peak output voltage	vs Output current	19
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los	Short-circuit output current	vs Supply voltage vs Free-air temperature	21 22
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A <sub>VD</sub>	Large-signal differential voltage amplification	vs Frequency vs Free-air temperature	26, 27 28, 29
z <sub>O</sub>	Output impedance	vs Frequency	30, 31
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ksvr	Supply-voltage rejection ratio	vs Frequency vs Free-air temperature	34, 35 36
I <sub>DD</sub>	Supply current	vs Supply voltage vs Free-air temperature	37 38
SR	Slew rate	vs Load capacitance vs Free-air temperature	39 40
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Vn	Equivalent input noise voltage	vs Frequency	49, 50
	Noise voltage (referred to input)	Over a 10-second period	51
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THD + N	Total harmonic distortion plus noise	vs Frequency	53
	Gain-bandwidth product	vs Free-air temperature vs Supply voltage	54 55
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A <sub>m</sub>	Gain margin	vs Load capacitance	57
B <sub>1</sub>	Unity-gain bandwidth	vs Load capacitance	58
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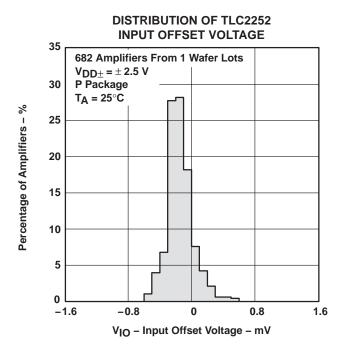
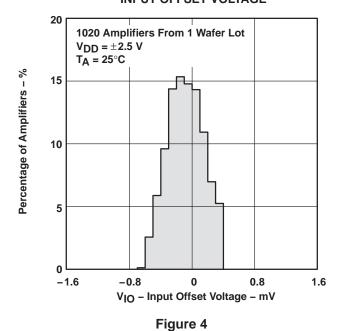


Figure 2

#### DISTRIBUTION OF TLC2254 INPUT OFFSET VOLTAGE



DISTRIBUTION OF TLC2252

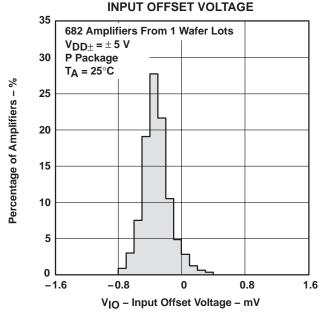


Figure 3

#### DISTRIBUTION OF TLC2254 INPUT OFFSET VOLTAGE

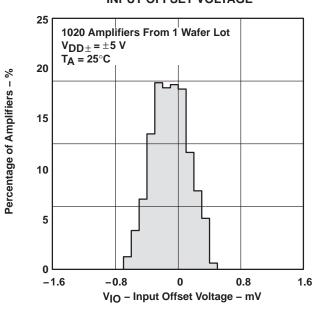
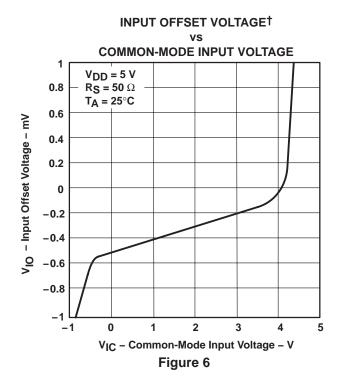
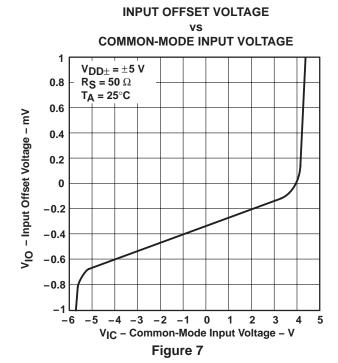
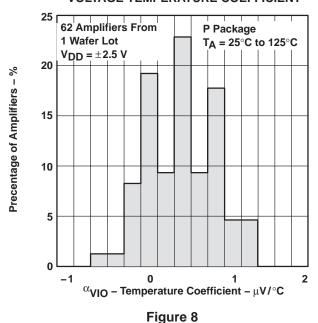


Figure 5

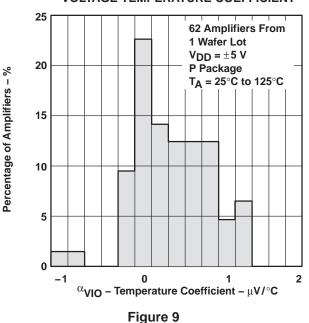




# DISTRIBUTION OF TLC2252 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT



# DISTRIBUTION OF TLC2252 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT



 $\dagger$  For curves where  $V_{DD}$  = 5 V, all loads are referenced to 2.5 V.



## **DISTRIBUTION OF TLC2254 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT 62 Amplifiers From** 1 Wafer Lot $V_{DD\pm} = \pm 2.5 \text{ V}$ 20 P Package Percentage of Amplifiers - % $T_A = 25^{\circ}C$ to $125^{\circ}C$ 15 10 5 -2 $\alpha_{\text{VIO}}$ – Temperature Coefficient of Input Offset Voltage – μV/°C

Figure 10

# INPUT BIAS AND INPUT OFFSET CURRENTS† FREE-AIR TEMPERATURE 35

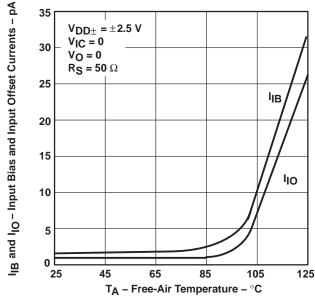
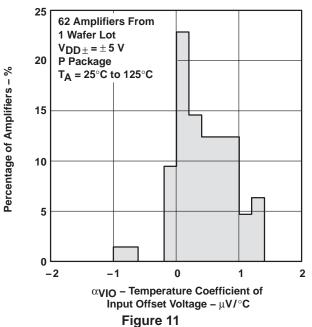


Figure 12

#### **DISTRIBUTION OF TLC2254 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT**



## **INPUT VOLTAGE RANGE SUPPLY VOLTAGE**

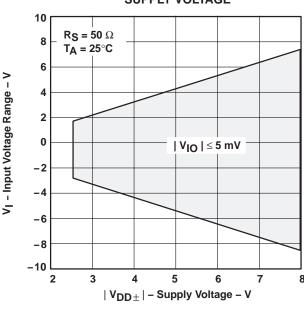


Figure 13

<sup>†</sup>Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



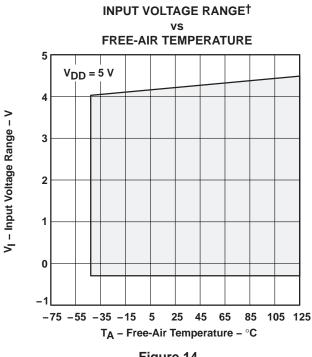


Figure 14

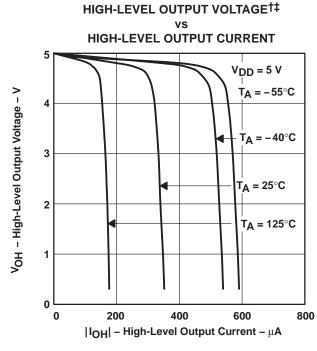
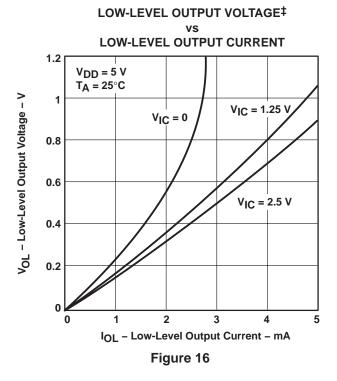


Figure 15





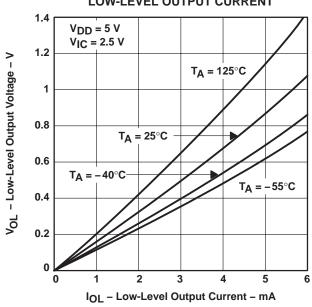


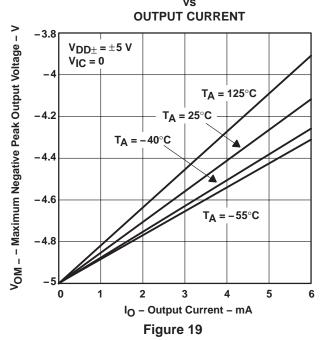
Figure 17

<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

 $<sup>\</sup>ddagger$  For curves where  $V_{DD} = 5$  V, all loads are referenced to 2.5 V.

# MAXIMUM POSITIVE PEAK OUTPUT VOLTAGE<sup>†</sup> **OUTPUT CURRENT** T<sub>A</sub> = 25°C $T_A = -40^{\circ}C$ 2 T<sub>A</sub> = 125°C $T_A = -55^{\circ}C$ $V_{DD} = \pm 5 V$ 0

MAXIMUM NEGATIVE PEAK OUTPUT VOLTAGE<sup>†</sup>



#### MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE‡

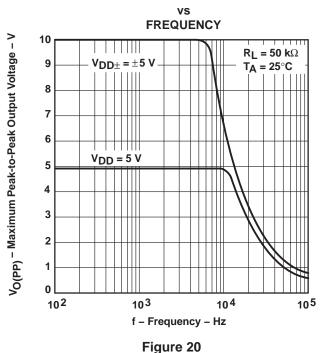
400

IO - Output Current - μA

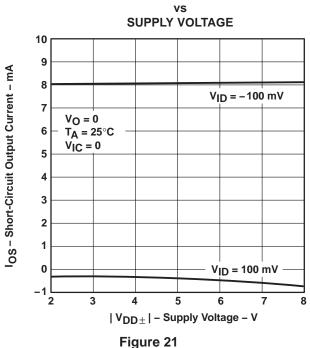
Figure 18

600

800



#### SHORT-CIRCUIT OUTPUT CURRENT



<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

<sup>‡</sup> For curves where V<sub>DD</sub> = 5 V, all loads are referenced to 2.5 V.



VOM + - Maximum Positive Peak Output Voltage - V

0

200

**OUTPUT VOLTAGE**‡

#### **TYPICAL CHARACTERISTICS**

#### SHORT-CIRCUIT OUTPUT CURRENT<sup>†</sup> FREE-AIR TEMPERATURE 11 $V_O = 0$ 10 $V_{DD}\pm = \pm 5 V$ IOS - Short-Circuit Output Current - mA 9 $V_{ID} = -100 \text{ mV}$ 8 7 6 $V_{ID} = 100 \text{ mV}$ 0 -75 -50 100 -25 25 50 75 125 T<sub>A</sub> - Free-Air Temperature - °C

Figure 22

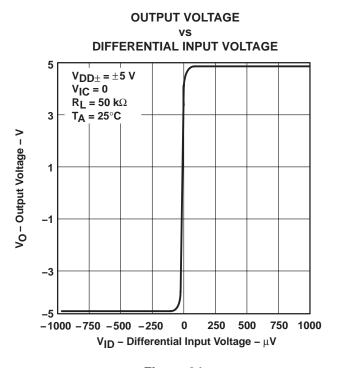


Figure 24

# VS DIFFERENTIAL INPUT VOLTAGE 5 VDD = 5 V RL = 50 kΩ VIC = 2.5 V 4 TA = 25°C 1 -1000 -750 -500 -250 0 250 500 750 1000 VID - Differential Input Voltage - μV

Figure 23

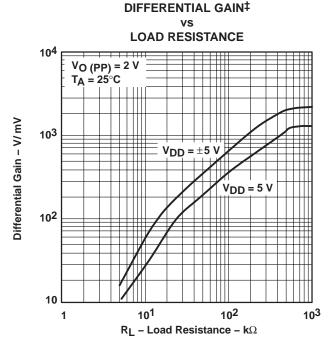


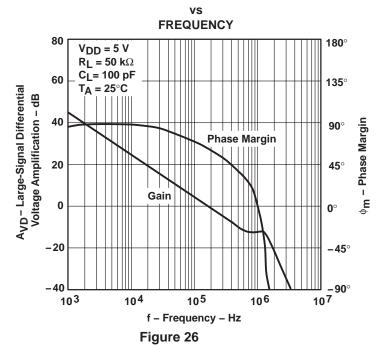
Figure 25

 $<sup>\</sup>ddagger$  For curves where  $V_{DD} = 5$  V, all loads are referenced to 2.5 V.



<sup>†</sup>Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

#### LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN<sup>†</sup>



#### LARGE-SIGNAL DIFFERENTIAL VOLTAGE **AMPLIFICATION AND PHASE MARGIN**

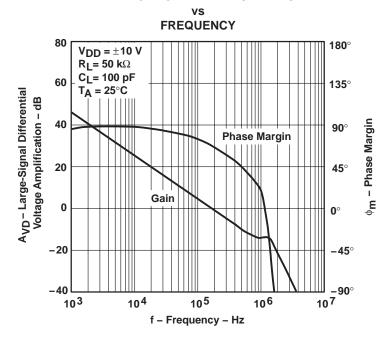


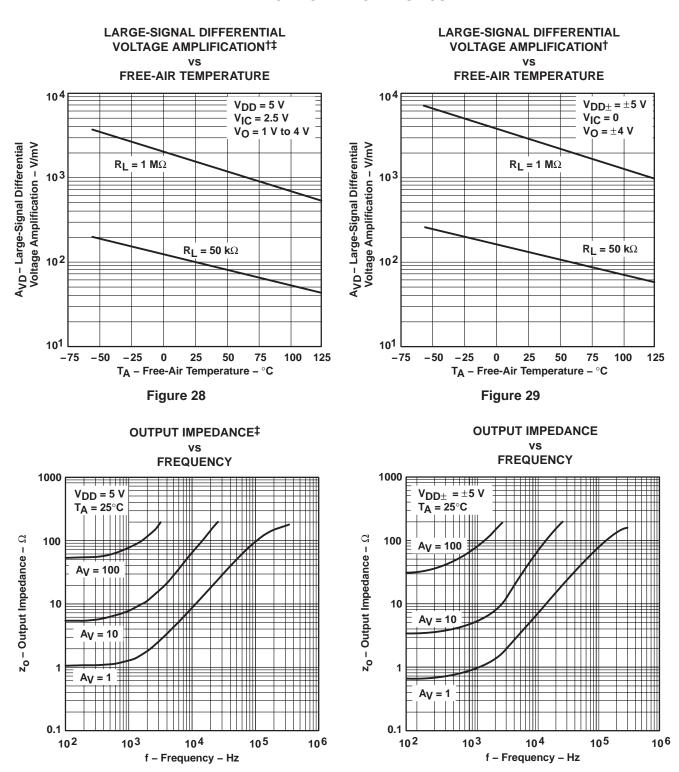
Figure 27

<sup>†</sup> For curves where  $V_{DD} = 5 \text{ V}$ , all loads are referenced to 2.5 V.



Figure 31

#### TYPICAL CHARACTERISTICS

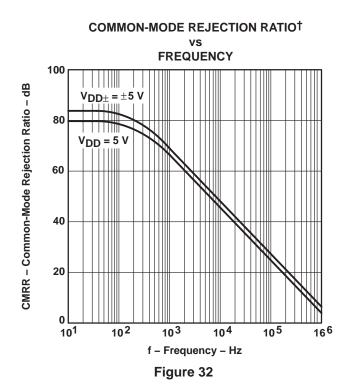


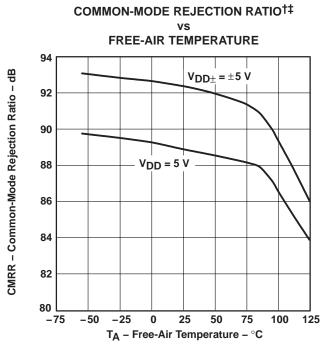
<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

Figure 30

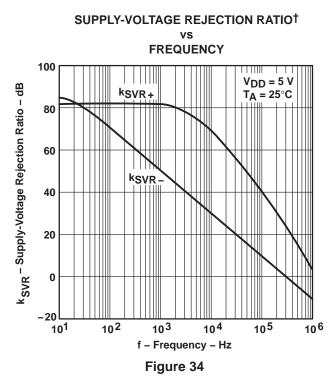


 $<sup>\</sup>ddagger$  For curves where  $V_{DD} = 5$  V, all loads are referenced to 2.5 V.

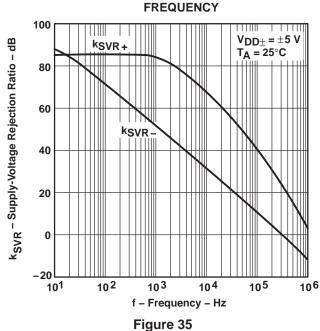




# Figure 33



# SUPPLY-VOLTAGE REJECTION RATIO

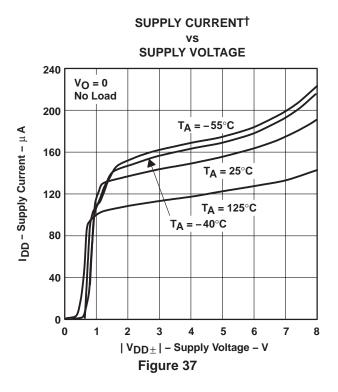


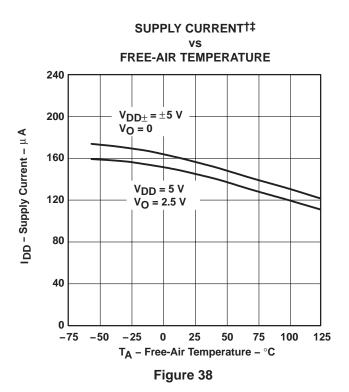
<sup>†</sup> For curves where  $V_{DD} = 5 \text{ V}$ , all loads are referenced to 2.5 V.

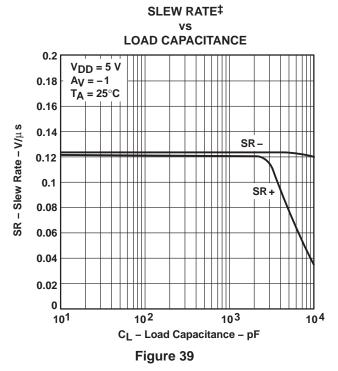
<sup>‡</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



## SUPPLY-VOLTAGE REJECTION RATIO† FREE-AIR TEMPERATURE 110 $V_{DD\pm}$ = ±2.2 V to ±8 V k<sub>SVR</sub> - Supply-Voltage Rejection Ratio - dB $V_{O} = 0$ 105 100 95 90 -75 -50 -25 25 75 100 125 T<sub>A</sub> – Free-Air Temperature – °C Figure 36



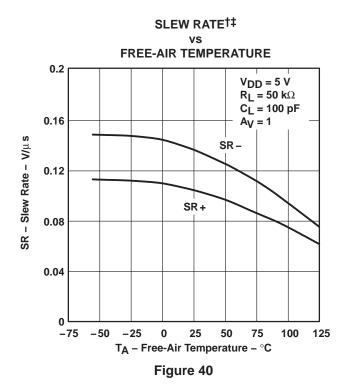


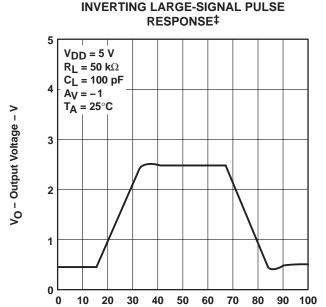


<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

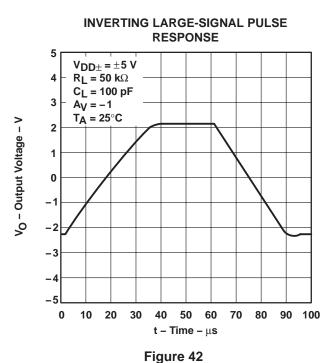
 $<sup>\</sup>ddagger$  For curves where  $V_{DD} = 5$  V, all loads are referenced to 2.5 V.







#### Figure 41





t – Time –  $\mu$ s

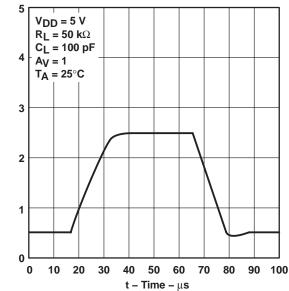


Figure 43

Vo - Output Voltage - V

<sup>‡</sup> For curves where  $V_{DD} = 5 \text{ V}$ , all loads are referenced to 2.5 V.



<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**INVERTING SMALL-SIGNAL** 

#### TYPICAL CHARACTERISTICS

#### **VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE**

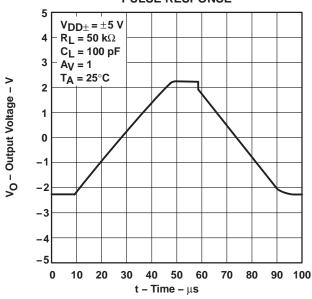


Figure 44

## **PULSE RESPONSE**† 2.65

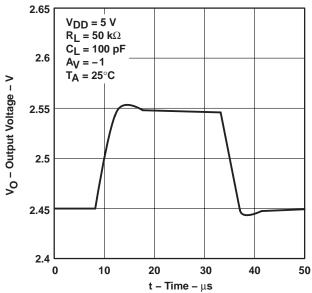


Figure 45

#### **INVERTING SMALL-SIGNAL PULSE RESPONSE**

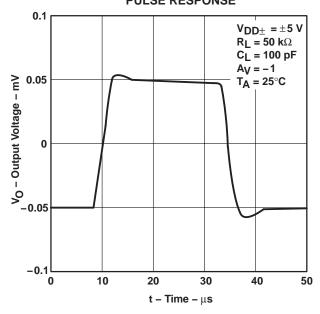


Figure 46

#### **VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE**†

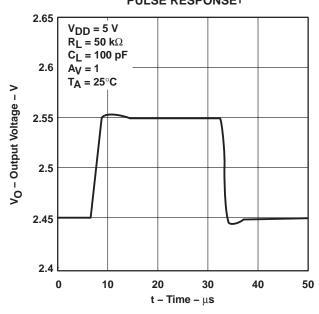


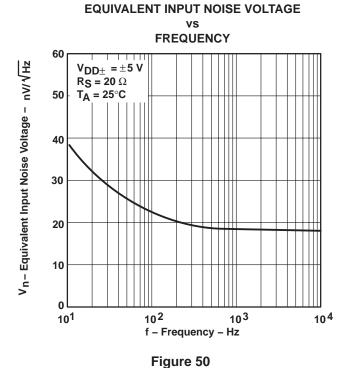
Figure 47

 $<sup>\</sup>dagger$  For curves where  $V_{DD}$  = 5 V, all loads are referenced to 2.5 V.



#### **VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE** 0.1 $V_{DD\pm} = \pm 5 V$ $R_L = 50 \text{ k}\Omega$ $C_L = 100 pF$ $A_V = 1$ T<sub>A</sub> = 25°C 0.05 V<sub>O</sub> - Output Voltage - V - 0.00 0.00 -0.10 10 20 30 40 50 t – Time – $\mu$ s

Figure 48



 $\dagger$  For curves where  $V_{DD}$  = 5 V, all loads are referenced to 2.5 V.

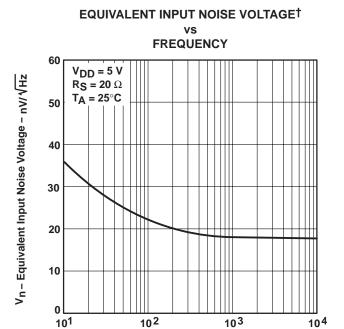


Figure 49

# EQUIVALENT INPUT NOISE VOLTAGE OVER A 10-SECOND PERIOD<sup>†</sup>

f - Frequency - Hz

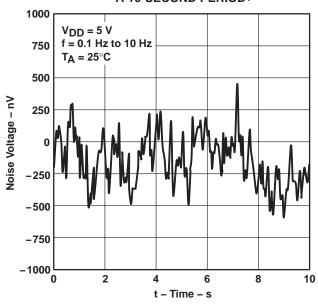


Figure 51



# INTEGRATED NOISE VOLTAGE VS FREQUENCY Calculated Using Ideal Pass-Band Filter Low Frequency = 1 Hz TA = 25°C Ta = 25°C 100 110 1101 102 103 104 105 f - Frequency - Hz

TOTAL HARMONIC DISTORTION PLUS NOISE<sup>†</sup>

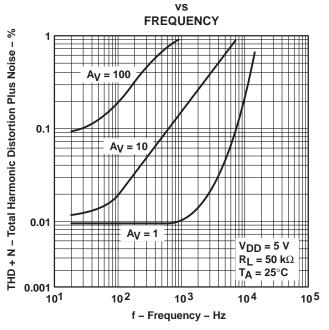
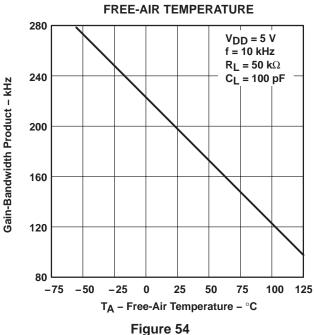


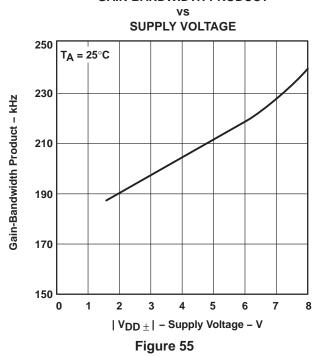
Figure 53



Figure 52



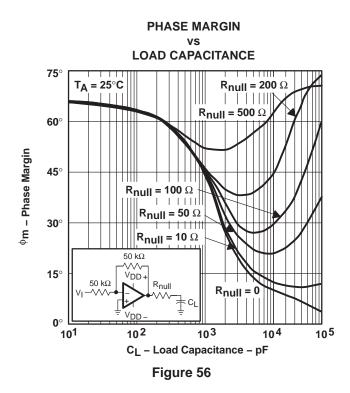
#### **GAIN-BANDWIDTH PRODUCT**

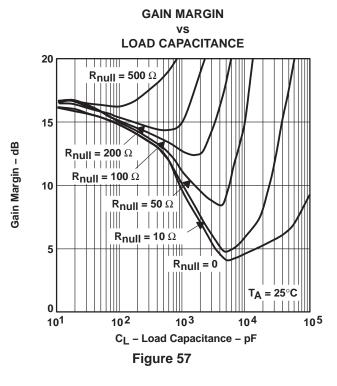


<sup>&</sup>lt;sup>†</sup> For curves where  $V_{DD} = 5 \text{ V}$ , all loads are referenced to 2.5 V.

<sup>‡</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.







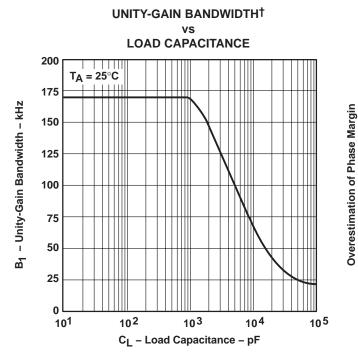


Figure 58



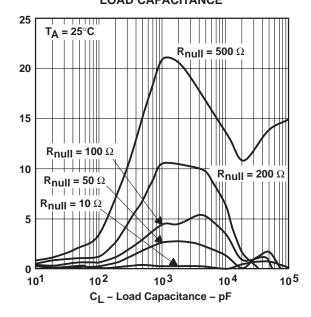


Figure 59



<sup>†</sup>See application information

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#### APPLICATION INFORMATION

#### driving large capacitive loads

The TLC225x is designed to drive larger capacitive loads than most CMOS operational amplifiers. Figure 56 and Figure 57 illustrate its ability to drive loads up to 1000 pF while maintaining good gain and phase margins  $(R_{null} = 0)$ .

A smaller series resistor ( $R_{null}$ ) at the output of the device (see Figure 60) improves the gain and phase margins when driving large capacitive loads. Figure 56 and Figure 57 show the effects of adding series resistances of 10  $\Omega$ , 50  $\Omega$ , 100  $\Omega$ , 200  $\Omega$ , and 500  $\Omega$ . The addition of this series resistor has two effects: the first is that it adds a zero to the transfer function and the second is that it reduces the frequency of the pole associated with the output load in the transfer function.

The zero introduced to the transfer function is equal to the series resistance times the load capacitance. To calculate the improvement in phase margin, equation 1 can be used.

$$\Delta \phi_{m1} = \tan^{-1} \left( 2 \times \pi \times UGBW \times R_{null} \times C_{L} \right)$$
 (1)

Where:

 $\Delta \phi_{m1}$  = Improvement in phase margin UGBW = Unity-gain bandwidth frequency

R<sub>null</sub> = Output series resistance

 $C_1$  = Load capacitance

The unity-gain bandwidth (UGBW) frequency decreases as the capacitive load increases (see Figure 58). To use equation 1, UGBW must be approximated from Figure 58.

Using equation 1 alone overestimates the improvement in phase margin, as illustrated in Figure 59. The overestimation is caused by the decrease in the frequency of the pole associated with the load, thus providing additional phase shift and reducing the overall improvement in phase margin.

Using Figure 60, with equation 1 enables the designer to choose the appropriate output series resistance to optimize the design of circuits driving large capacitance loads.

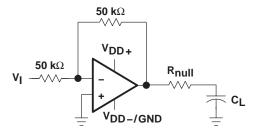


Figure 60. Series-Resistance Circuit

#### **APPLICATION INFORMATION**

#### macromodel information

Macromodel information provided was derived using MicroSim  $Parts^{TM}$ , the model generation software used with MicroSim  $PSpice^{TM}$ . The Boyle macromodel (see Note 5) and subcircuit in Figure 61 are generated using the TLC225x typical electrical and operating characteristics at  $T_A = 25$ °C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification

- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 4: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

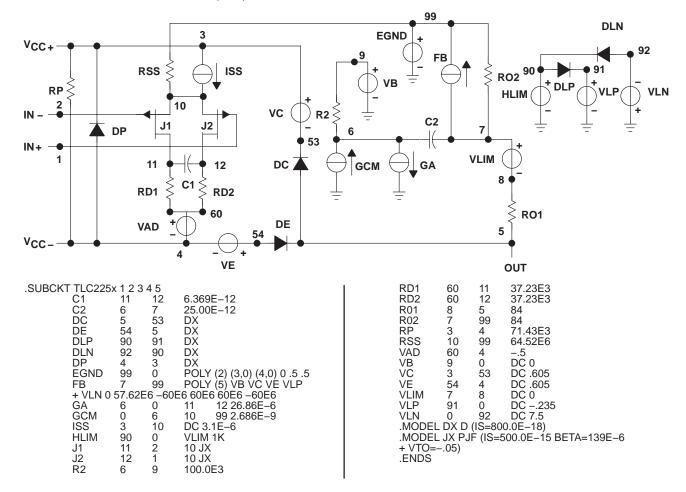


Figure 61. Boyle Macromodel and Subcircuit

PSpice and Parts are trademarks of MicroSim Corporation.









#### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	n MSL Peak Temp <sup>(3)</sup>
TLC2252AQDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2252AQDRQ1	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
TLC2252AQPWRG4Q1	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2252AQPWRQ1	ACTIVE	TSSOP	PW	8	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
TLC2252QDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2252QDRQ1	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
TLC2252QPWRG4Q1	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2252QPWRQ1	ACTIVE	TSSOP	PW	8	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
TLC2254AQDRG4Q1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2254AQDRQ1	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
TLC2254AQPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2254AQPWRQ1	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
TLC2254QDRG4Q1	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2254QDRQ1	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
TLC2254QPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC2254QPWRQ1	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



#### PACKAGE OPTION ADDENDUM

18-Sep-2008

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#### OTHER QUALIFIED VERSIONS OF TLC2252-Q1, TLC2252A-Q1, TLC2254-Q1, TLC2254A-Q1:

- Catalog: TLC2252, TLC2252A, TLC2254, TLC2254A
   Enhanced Product: TLC2252-EP, TLC2252A-EP, TLC2254-EP, TLC2254A-EP
- Military: TLC2252M, TLC2252AM, TLC2254AM, TLC2254AM

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

#### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

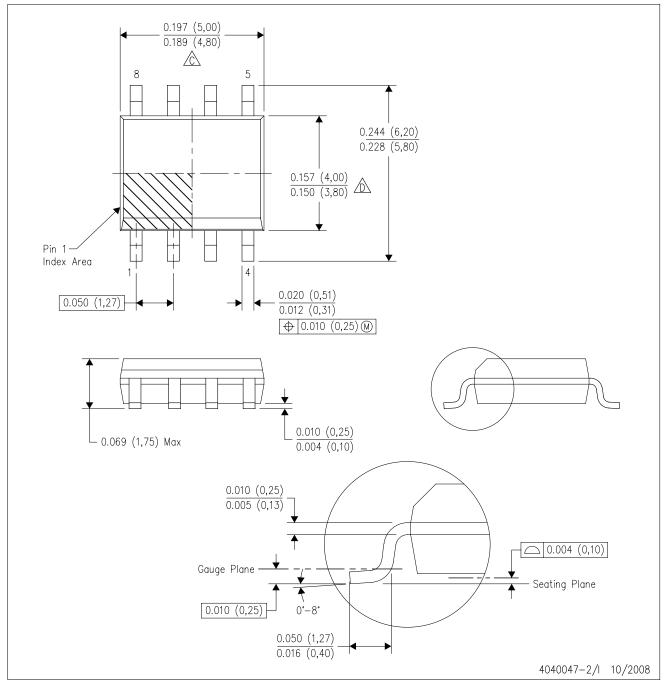
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

## D (R-PDSO-G8)

#### PLASTIC SMALL-OUTLINE PACKAGE



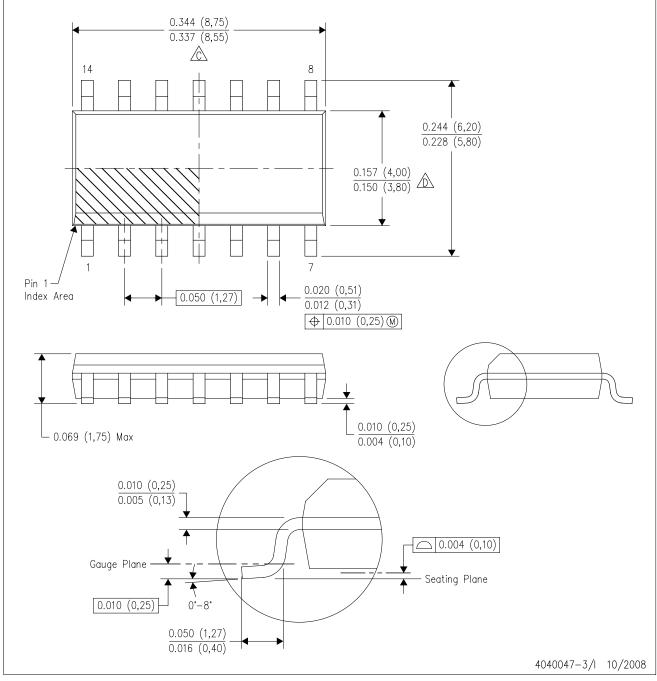
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



## D (R-PDSO-G14)

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



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